

30V N-Channel Enhancement Mode MOSFET

Voltage

30 V

Current

138 A

Features

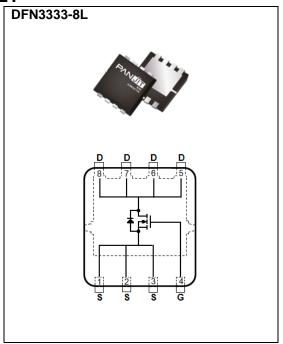
- RDS(ON), VGS@10V, ID@20A<2.5m Ω
- RDS(ON), VGS@4.5V, ID@10A<3.9mΩ
- Excellent FOM
- Logic Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: DFN3333-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.03 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V_{DS}	30	V	
Gate-Source Voltage		V_{GS}	±20		
Continuous Drain Current(Note 3)	Tc=25°C		138		
	T _C =100°C	l _D	98	Α	
Pulsed Drain Current(Note 1)	T _C =25°C	I _{DM}	552		
Power Dissipation	T _C =25°C	-	86	W	
	T _C =100°C	Po	43		
Continuous Drain Current(Note 4)	T _A =25°C	I _D	23.6		
	T _A =70°C		19.7	Α	
Power Dissipation	T _A =25°C	D-	2.5	W	
	T _A =70°C	Po	1.8		
Single Pulse Avalanche Current(Note 5)		I _{AS}	13.8	Α	
Single Pulse Avalanche Energy ^(Note 5)		Eas	79	mJ	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~175	°C	
Thermal Resistance ^(Note 4)	Junction to Case	R _{θJC}	1.75	°C/W	
	Junction to Ambient	$R_{\theta JA}$	60		



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _G s=0V, I _D =250uA	30	-	-	- 2.3
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1.1	1.5	2.3	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A	-	2	2.5	mΩ
		V _{GS} =4.5V, I _D =10A	-	3	3.9	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Dynamic ^(Note 6)						
Total Gate Charge	Q_g	V _{DS} =24V, I _D =20A,	1	43	56	nC
Gate-Source Charge	Q_{gs}		1	5.4	-	
Gate-Drain Charge	Q_{gd}	V _{GS} =10V ^(Note 2,3)	-	5.5	-	
Input Capacitance	Ciss	V _{DS} =25V, V _{GS} =0V, f=1MHz	-	2250	2925	pF
Output Capacitance	Coss		ı	716	1002	
Reverse Transfer Capacitance	Crss		-	67	120	
Gate resistance	Rg	f=1MHz	-	2.5	-	Ω
Turn-On Delay Time	td _(on)	V _{DS} =24V, I _D =20A, V _{GS} =10V, R _G =3Ω (Note 2,3)	-	9.6	-	ns
Turn-On Rise Time	tr		-	7.4	-	
Turn-Off Delay Time	td _(off)		-	37	-	
Turn-Off Fall Time	tf	(NOTE 2,3)	-	10	-	
Drain-Source Diode						
Diode Forward Current	Is	T 0500	1	-	138	Α
Pulsed Diode Forward Current	I _{SM}	T _C =25°C	ı	-	552	
Diode Forward Voltage	V _{SD}	I _S =20A, V _{GS} =0V	-	0.8	1.3	V
Reverse Recovery Time	Trr	V _{DD} =24V, V _{GS} =0V,	ı	30	-	ns
Reverse Recovery Charge	Qrr	Is=20A,dIs/dt=100A/us	-	15	-	nC

NOTES:

- 1. Pulse width<100us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an ReJc=1.75°C/W, Package limited 100A.
- 4. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. E_{AS} is calculated based on the condition of L=1mH, I_{AS} =12.6A, V_{DD} =30V, V_{GS} =10V. 100% test at L=0.5mH, I_{AS} =13.8A in production.
- 6. Guaranteed by design, not subject to production testing.



TYPICAL CHARACTERISTIC CURVES

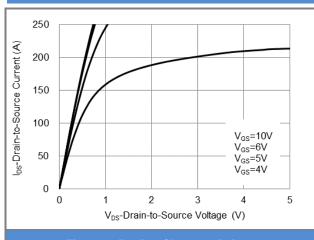


Fig.1 On-Region Characteristics

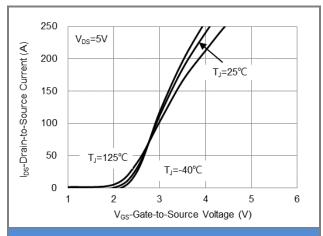


Fig.2 Transfer Characteristics

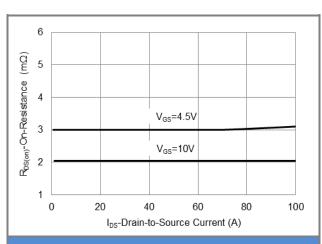


Fig.3 On-Resistance vs. Drain Current

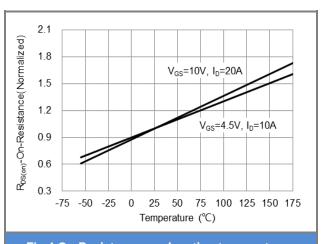


Fig.4 On-Resistance vs. Junction temperature

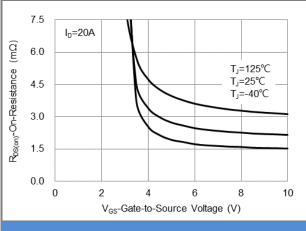


Fig.5 On-Resistance Variation with V_{GS}

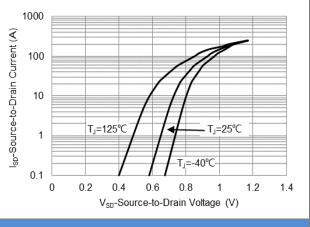


Fig.6 Source-Drain Diode Forward Voltage



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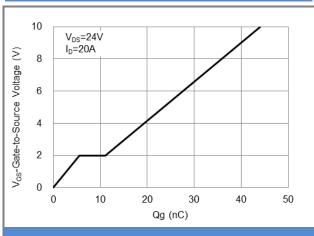


Fig.7 Gate-Charge Characteristics

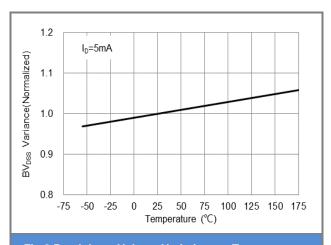


Fig.8 Breakdown Voltage Variation vs. Temperature

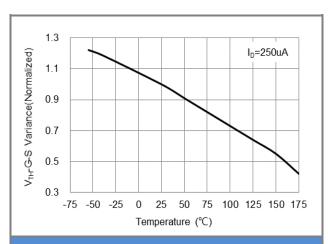


Fig.9 Threshold Voltage Variation with Temperature

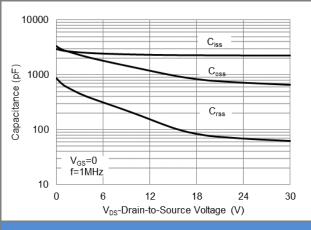


Fig.10 Capacitance vs. Drain-Source Voltage

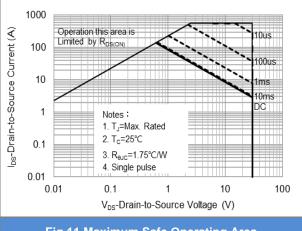


Fig.11 Maximum Safe Operating Area

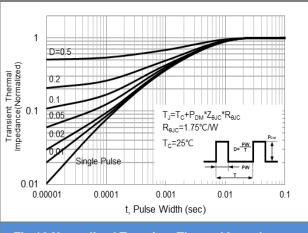


Fig.12 Normalized Transient Thermal Impedance



TYPICAL CHARACTERISTIC CURVES

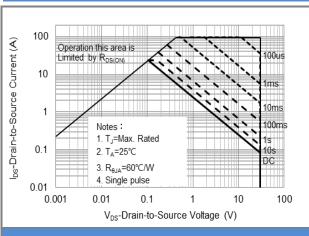


Fig.13 Maximum Safe Operating Area

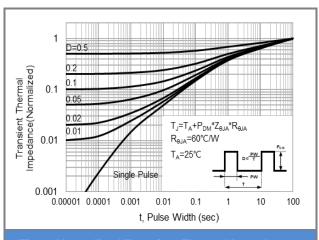


Fig.14 Normalized Transient Thermal Impedance

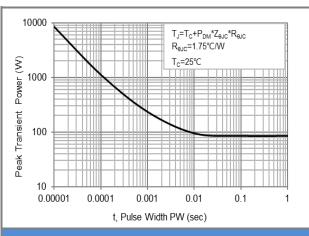


Fig.15 Single Pulse Maximum Power Dissipation

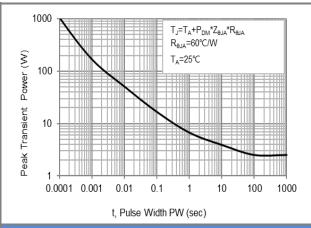


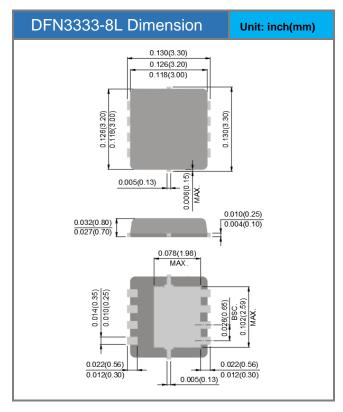
Fig.16 Single Pulse Maximum Power Dissipation

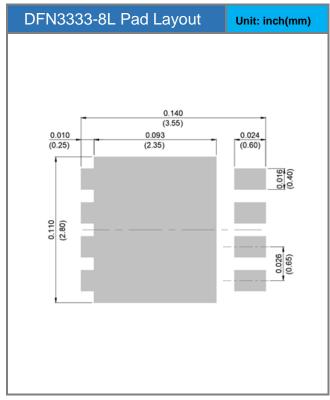


Product and Packing Information

Part No.	Package Type	Packing Type	Marking	
PJQ4520S6P-AU	DFN3333-8L	5K pcs / 13" reel	520W	

Packaging Information & Mounting Pad Layout







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